# P \$40.00 1191

# PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Kazunari Maki	03/04/2008
Yuji Nakata	03/04/2008

## **RECEIVING PARTY DATA**

Name:	Tanaka Denshi Kogyo K.K.	
Street Address:	Tokyo Building 22F, 2-7-3, Marunouchi, Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11917241

## **CORRESPONDENCE DATA**

Fax Number: (212)527-7701

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (212) 527-7700

Email: mhasegawa@darbylaw.com

Correspondent Name: Joseph R. Robinson

Address Line 1: P.O. Box 770, Church Street Station
Address Line 4: NEW YORK, NEW YORK 10008-0770

ATTORNEY DOCKET NUMBER:	09852/0208695-US0
NAME OF SUBMITTER:	Mami Hasegawa

Total Attachments: 2

source=01578504#page1.tif source=01578504#page2.tif

> PATENT REEL: 021131 FRAME: 0694

500573155

Attorney Docket No.:

ASSIGNMENT			
I, Kazunari MAKI, a citizen of Japan, residing at			
Naka-gun ; JAPAN; and			
I, Yuji NAKATA, a citizen of Japan, residing at			
Sanda-shi ; JAPAN;			
,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			
and each of us, if more than one person is identified above (hereinafter "ASSIGNOR") in			
consideration of the sum of Ten Dollars (\$10.00), or the equivalent thereof, and other good and			
valuable consideration, the sufficiency of which and receipt of which are hereby acknowledged,			
paid to ASSIGNOR by TANAKA DENSHI KOGYO K.K.			
a corporation organized under the laws of Japan, located at Tokyo Building 22F, 2-7-3,			
Marunouchi, Chiyoda-ku, Tokyo, Japan (hereinafter "ASSIGNEE"), do hereby sell and assign			
to said ASSIGNEE, its successors and assigns, the below indicated right, title, and interest, in			
and for the United States of America only in and to my Invention entitled:			
GOLD ALLOY WIRE FOR BONDING WIRE HAVING HIGH BONDING RELIABILITY,			
HIGH ROUNDNESS OF COMPRESSION BALL, HIGH STRAIGHTNESS AND HIGH RESIN			
FLOWABILITY RESISTANCE			
invented by me and described in the specification bearing the above Attorney Docket No. and			
title executed by me concurrently herewith; and Patent Application No, filed			
on, in Japan and all patents, divisions, reissues, continuations and any			
extensions thereof and rights of priority therein, said interest being my entire ownership interest			
in the same, to be held and enjoyed by said ASSIGNEE, its successors, assigns, or other legal			
representatives, to the full end of the term thereof, as fully and entirely as the same would have			
been held and enjoyed by me if this assignment and sale had not be made;			
And for the consideration aforesaid, I hereby covenant and agree to and with said			
ASSIGNEE, its successors and assigns, that whenever ASSIGNEE, its counsel or			

representative, or the counsel or representative of its successors or assigns, shall advise that an

1

amendment to, or a division of, or any other proceeding or action in connection with an

PATENT REEL: 021131 FRAME: 0695 application concerning said Invention, including interference proceedings, is lawful and desirable, or that a reissue or continuation or extension of such application or patent issuing therefrom is lawful and desirable, I will sign all papers and drawings, take all rightful oaths and affidavits, and do all acts necessary or required to be done for the procurement of all lawful rights associated with the Invention, or for the reissue or continuation or extension of the same, will do all acts necessary or required to secure in said ASSIGNEE, its successors or assigns, the title to and full benefit of all rights hereby assigned, without charge to said ASSIGNEE or its successors or assigns, but at its or their expense; and I hereby appoint every present or future officer of said ASSIGNEE as my agent to sign all such papers and to do all such necessary acts on my behalf, to the fullest extent permitted by law;

And I hereby authorize and request the Commission of Patents and Trademarks and any other granting authority to issue any Letters Patent resulting from said Invention and application(s) concerning same to said ASSIGNEE.

This assignment shall have an effective date corresponding to the last date of execution.

I declare under penalty of perjury under the laws of the United States of America, and under penalty of the laws of any other jurisdiction before which this document may be presented, that I have signed this document as my own free act and that all of the foregoing is true and correct.

Dated: March 4, 2008

| Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008 | Dated: March 4, 2008